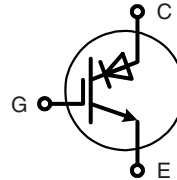
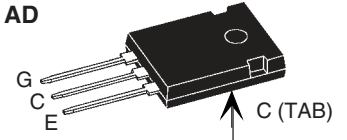


IGBT with Reverse Blocking capability

$$V_{CES} = \pm 1200 \text{ V}$$

$$I_{C25} = 55 \text{ A}$$

$$V_{CE(sat)} = 2.3 \text{ V typ.}$$


TO-247 AD


G = Gate,
E = Emitter,
C = Collector,
TAB = Collector

IGBT			
Symbol	Conditions	Maximum Ratings	
V_{CES}	$T_{VJ} = 25^{\circ}\text{C}$ to 150°C	± 1200	V
V_{GES}		± 20	V
I_{C25}	$T_C = 25^{\circ}\text{C}$	55	A
I_{C90}	$T_C = 90^{\circ}\text{C}$	35	A
I_{CM}	$V_{GE} = 0/15 \text{ V}$; $R_G = 22 \Omega$; $T_{VJ} = 125^{\circ}\text{C}$	80	A
V_{CEK}	RBSOA, Clamped inductive load; $L = 100 \mu\text{H}$	600	V
P_{tot}	$T_C = 25^{\circ}\text{C}$	300	W

Features

- IGBT with NPT (non punch through) structure
- reverse blocking capability
 - function of series diode monolithically integrated, no external series diode required
 - soft reverse recovery
- positive temperature coefficient of saturation voltage
- Epoxy of TO-247 package meets UL 94V-0

Applications

converters requiring reverse blocking capability:

- current source inverters
- matrix converters
- bi-directional switches
- resonant converters
- induction heating
- auxiliary switches for soft switching in the main current path

Symbol	Conditions	Characteristic Values ($T_{VJ} = 25^{\circ}\text{C}$, unless otherwise specified)		
		min.	typ.	max.
$V_{CE(sat)}$	$I_C = 30 \text{ A}$; $V_{GE} = 15 \text{ V}$; $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$		2.3 2.8	2.7 V V
$V_{GE(th)}$	$I_C = 2 \text{ mA}$; $V_{GE} = V_{CE}$	4		8 V
I_{CES}	$V_{CE} = V_{CES}$; $V_{GE} = 0 \text{ V}$; $T_{VJ} = 25^{\circ}\text{C}$ $T_{VJ} = 125^{\circ}\text{C}$		3.0	50 μA mA
I_{GES}	$V_{CE} = 0 \text{ V}$; $V_{GE} = \pm 20 \text{ V}$			500 nA
Q_{Gon}	$V_{CE} = 120\text{V}$; $V_{GE} = 15 \text{ V}$; $I_C = 35 \text{ A}$		90	nC

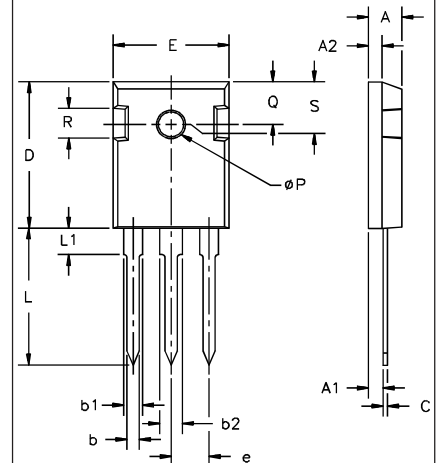
IGBT

Symbol	Conditions	Characteristic Values	
		(T _{VJ} = 25°C, unless otherwise specified)	
		typ.	
External diode DSEP30-12 - diagram see Fig. 17			
t _{d(on)}	Inductive load, T _{VJ} = 125°C V _{CE} = 600 V; I _C = 35 A V _{GE} = ±15 V; R _G = 15 Ω	31	ns
t _r		54	ns
t _{d(off)}		184	ns
t _f		24	ns
E _{on}		3.0	mJ
E _{off}		0.7	mJ
Internal diode - diagram see Fig. 18			
t _{d(on)}	Inductive load, T _{VJ} = 125°C V _{CE} = 600 V; I _C = 35 A V _{GE} = ±15 V; R _G = 15 Ω	29.5	ns
t _r		47	ns
t _{d(off)}		183	ns
t _f		46	ns
E _{on}		19.2	mJ
E _{off}		1.0	mJ
E _{rec int}	7	mJ	
I _{RM}	I _F = 35 A; di _C /dt = -50 A/μs; T _{VJ} = 125°C	28.5	A
t _{rr}	V _{CE} = -600 V; V _{GE} = 15 V	2.1	μs
R _{thJC}		0.42	K/W

Component

Symbol	Conditions	Maximum Ratings	
T _{VJ}		-55...+150	°C
T _{stg}		-55...+125	°C
M _d	mounting torque	0.8 - 1.2	Nm
F _C	mounting force with clip	20...120	N

Symbol	Conditions	Characteristic Values		
		min.	typ.	max.
R _{thCH}	with heatsink compound	0.25		K/W
Weight		6		g

TO-247 AD Outline


Dim.	Millimeter		Inches	
	Min.	Max.	Min.	Max.
A	4.7	5.3	.185	.209
A ₁	2.2	2.54	.087	.102
A ₂	2.2	2.6	.059	.098
b	1.0	1.4	.040	.055
b ₁	1.65	2.13	.065	.084
b ₂	2.87	3.12	.113	.123
C	.4	.8	.016	.031
D	20.80	21.46	.819	.845
E	15.75	16.26	.610	.640
e	5.20	5.72	0.205	0.225
L	19.81	20.32	.780	.800
L1		4.50		.177
∅P	3.55	3.65	.140	.144
Q	5.89	6.40	0.232	0.252
R	4.32	5.49	.170	.216
S	6.15	BSC	242	BSC

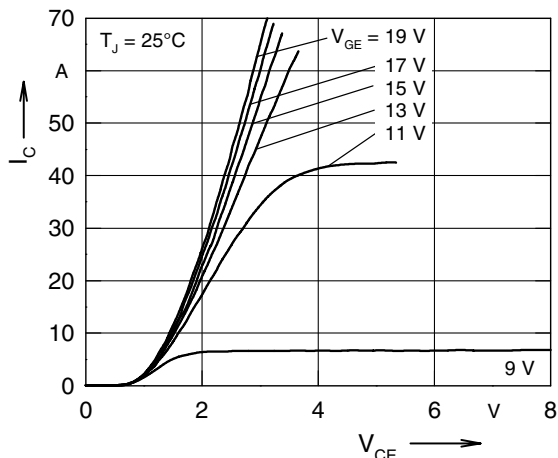


Fig. 1 Typical output characteristics

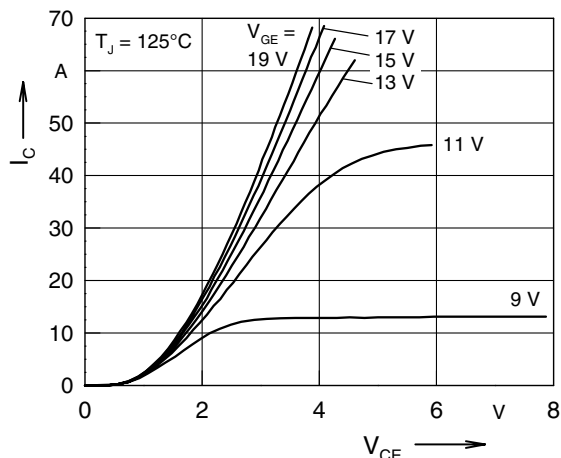


Fig. 2 Typical output characteristics

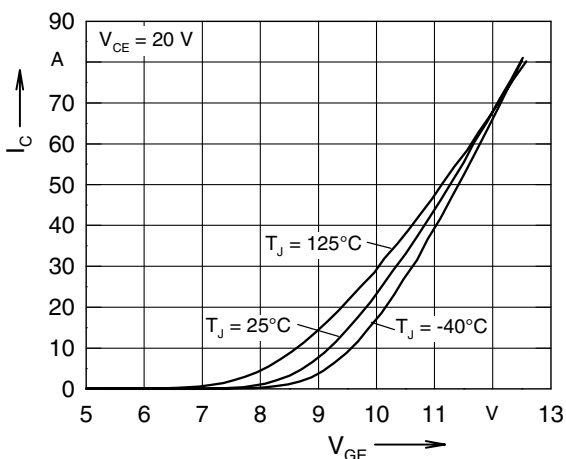


Fig. 3 Typical transfer characteristics

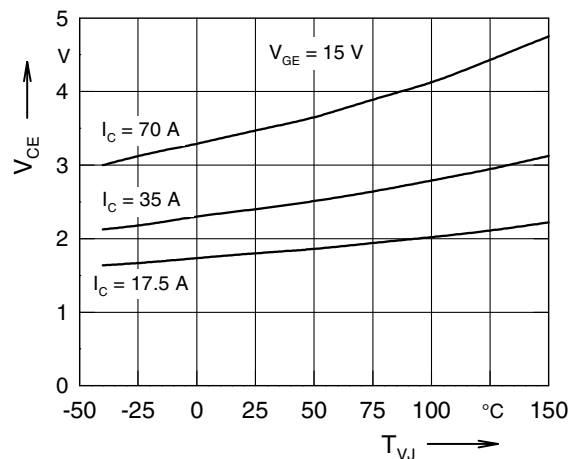


Fig. 4 Typ. collector emitter saturation as a function of case temperature

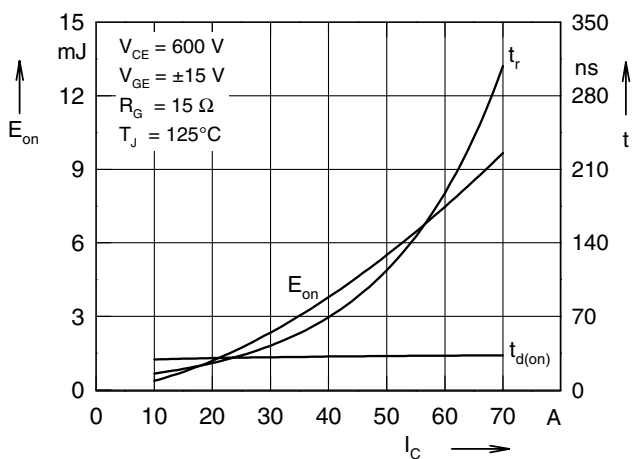


Fig. 5 Typ. turn on energy and switching times vs. collector current, inductive switching with ext. free wheeling diode (Fig. 17)

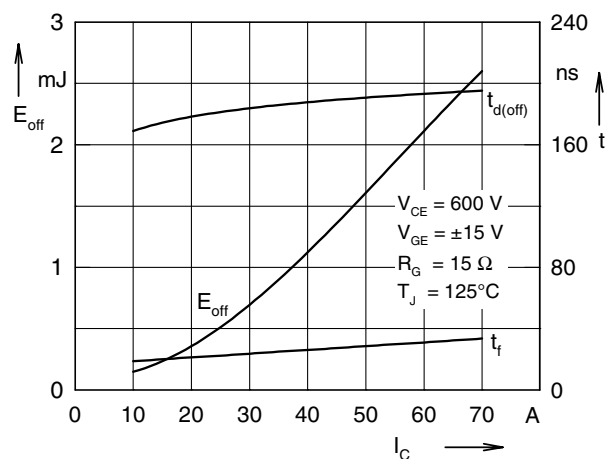


Fig. 6 Typ. turn off energy and switching times vs. collector current, inductive switching with ext. free wheeling diode (Fig. 17)

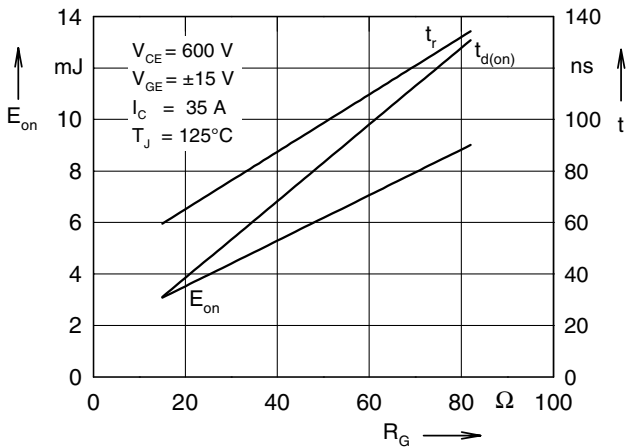


Fig. 7 Typ. turn on energy and switching times vs. gate resistor, inductive switching with ext. free wheeling diode (Fig. 17)

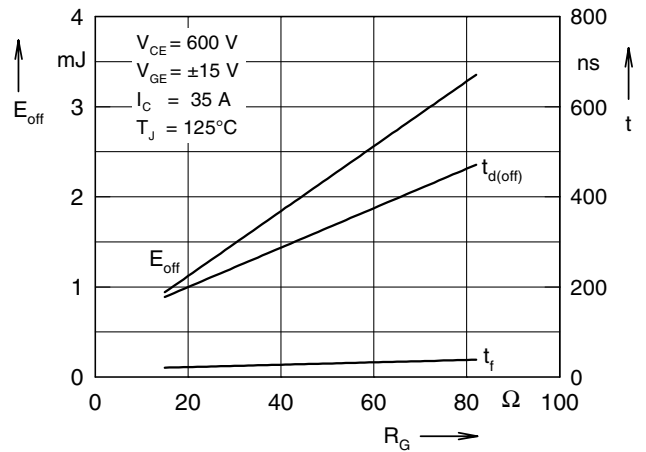


Fig. 8 Typ. turn off energy and switching times vs. gate resistor, inductive switching with ext. free wheeling diode (Fig. 17)

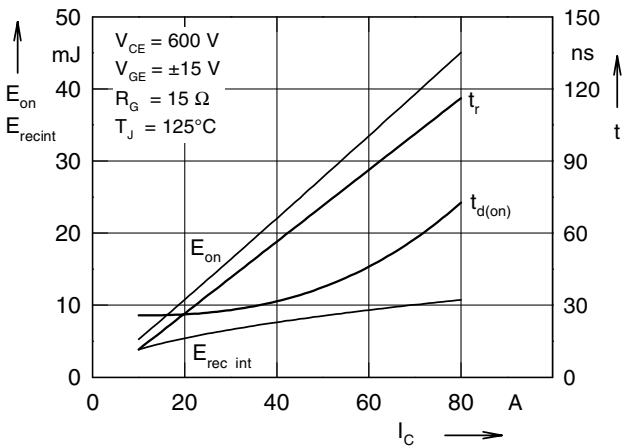


Fig. 9 Typ. turn on energy and switching times vs. collector current, inductive switching with internal diode (Fig. 18)

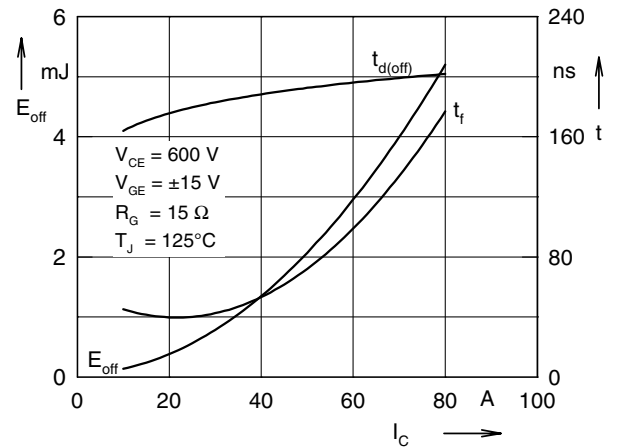


Fig. 10 Typ. turn off energy and switching times vs. collector current, inductive switching with internal diode (Fig. 18)

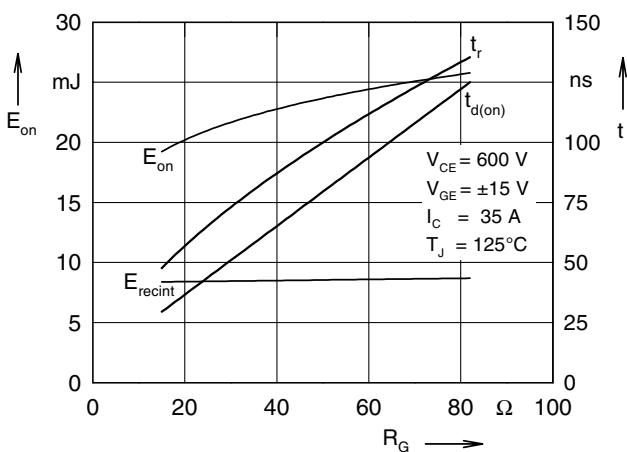


Fig. 11 Typ. turn on energy and switching times vs. gate resistor, inductive switching with internal diode (Fig. 18)

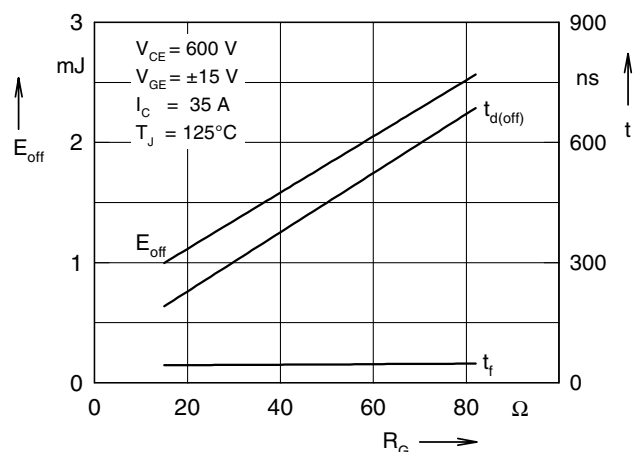


Fig. 12 Typ. turn off energy and switching times vs. gate resistor, inductive switching with internal diode (Fig. 18)

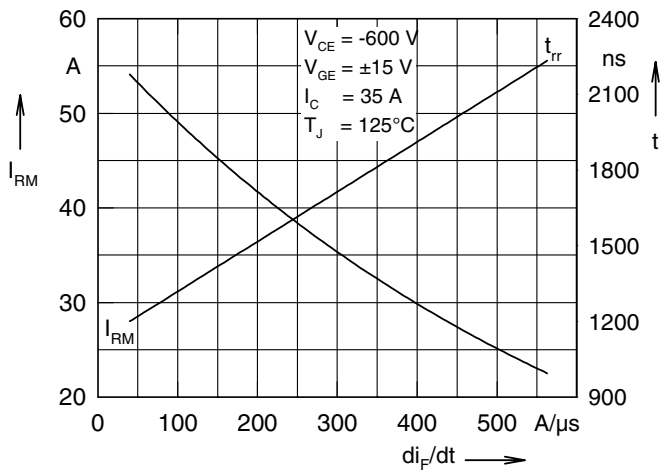


Fig. 13 Typ. turn off characteristics of the internal diode

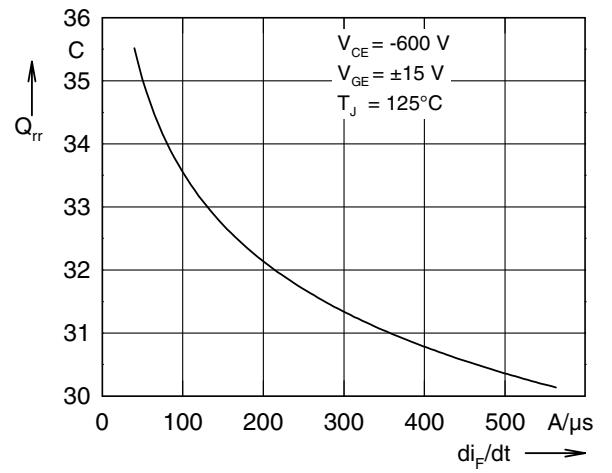


Fig. 14 Typ. turn off characteristics of the internal diode

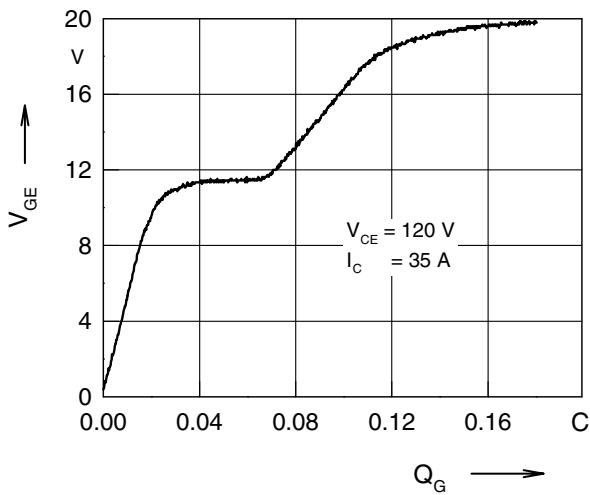


Fig. 15 Typical gate charge

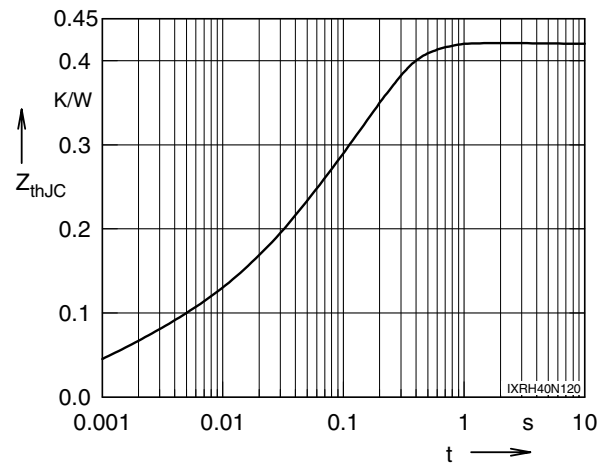


Fig. 16 Typ. transient thermal impedance

Ri	0.034	0.048	0.092	0.174	0.075
τ	0.0001	0.0035	0.02	0.142	0.18

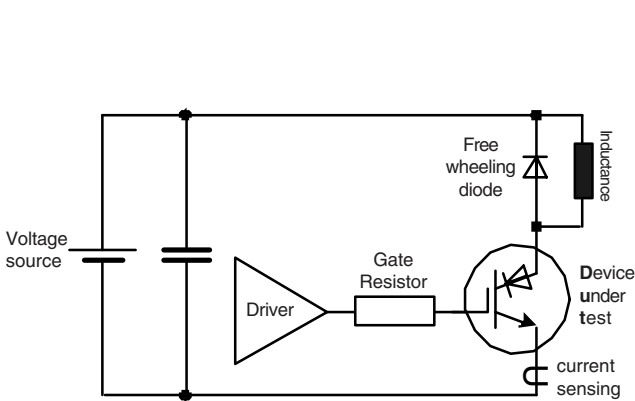


Fig. 17 turn-on/turn-off with external diode (DSEP 30-12)

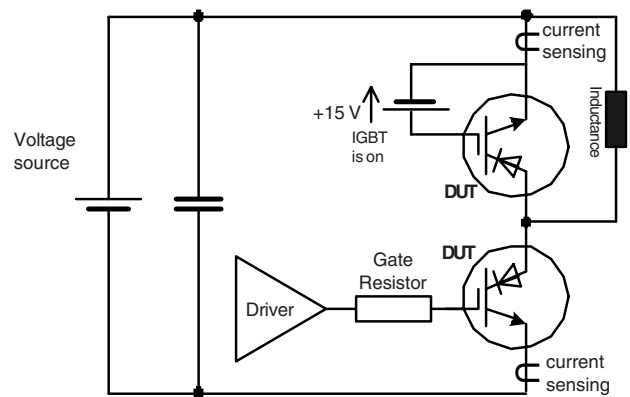


Fig. 18 turn-on/turn-off with internal diode